## **P6KE550**

# **Transient Voltage Suppressors**

Pppm: 600W IFSM: 100A



#### **FEATURE**

Low power loss
High surge capability
Glass passivated chip junction
High temperature soldering guaranteed
250°C/10sec/0.375" lead length at 5 lbs tension

### **MECHANICAL DATA**

Terminal: Plated axial leads solderable per

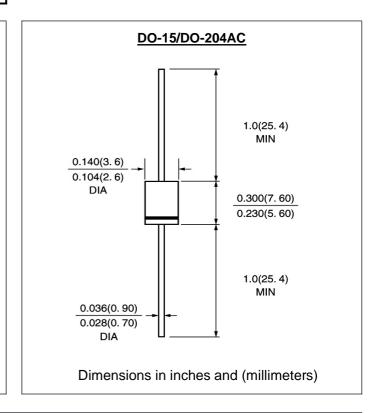
MIL-STD 202E, method 208C

Case: Molded with UL-94 Class V-0 recognized Flame

Retardant Epoxy

Polarity: color band denotes cathode

Mounting position: any



$\begin{array}{c} MAXIMUM \\ (TA = 25~\mathbb{C} \; unless \end{array}$		ed)	
PARAMETER	SYMBOL	P6KE550	unit
Peak power dissipation with a 10/1000 µs waveform (1) (Fig. 1)	P <sub>PPM</sub>	600	W
Peak pulse current with a 10/1000 µs waveform (1)	I <sub>PPM</sub>	0.77	А
Breakdown Voltage at I <sub>T</sub> =1mA	$V_{BR}$	495min 605max	V
Maximum Reverse Leakage at V <sub>WM</sub> =445V	$I_R$	1.0	μA
Maximum Clamping Voltage at IPPM	V <sub>C</sub>	786	V
Power dissipation on infinite heatsink at TL = 75 ℃ (Fig. 5)	P <sub>D</sub>	5.0	W
Peak forward surge current, 8.3 ms single half sine-wave (2)	I <sub>FSM</sub>	100	А
Maximum instantaneous forward voltage at 50 A for unidirectional only	$V_{F}$	5.0	V
Typical thermal resistance junction-to-lead	Rth(jl)	20	€\
Typical thermal resistance junction-toambient	Rth(ja)	75	<b>℃</b> /V
Storage and Operating Junction Temperature	Tstg,Tj	-55 to +175	°C

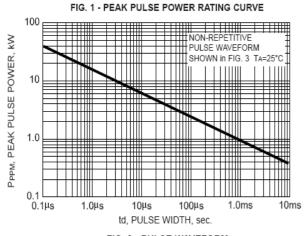
Note

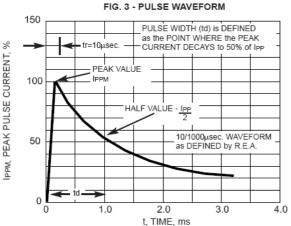
(1) Non-repetitive current pulse, per Fig. 3 and derated above TA = 25 ℃ per Fig. 2

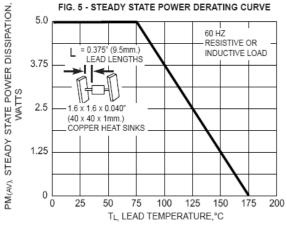
(2) Measured on 8.3 ms single half sine-wave or equivalent square wave, duty cycle = 4 per minute maximum

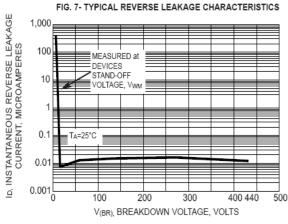
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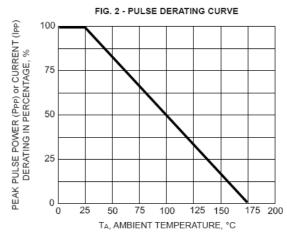
#### **RATINGS AND CHARACTERISTIC CURVES P6KE550**

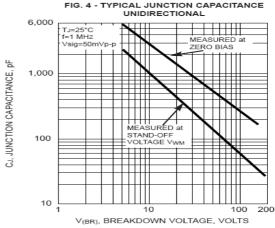


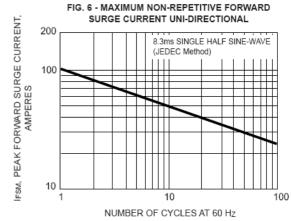


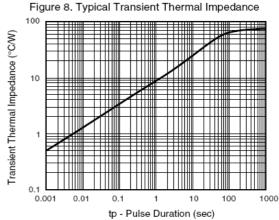












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